

PRODUCT NUMBER
98464-X61-XXXLF

PLATING

S = 0.38µm GOLD
ON CONTACT AREA
3.81µm TIN LEAD
ON TAIL

G = 0.76µm GOLD
ON CONTACT AREA
3.81µm TIN LEAD
ON TAIL

F = GOLD FASH
ON CONTACT AREA
3.81µm TIN LEAD
ON TAIL

WHEN REQUIRED, ADD SUFFIX LETTER "LF"
INDICATES THE PRODUCT IS RoHS
COMPATIBLE, SEE NOTE 8

PACKAGING OPTIONAL LETTER (SEE NOTE 5)

TOTAL NB OF POSITIONS, 04 TO 50

NOTES:

1. MATERIAL HOUSING: HIGH TEMP. THERMOPLASTIC
UL 94V-0, COLOR CREAM
2. MATERIAL TERMINAL: COPPER ALLOY
3. TO DETERMINE DIMENSIONS:
N = NUMBER OF POSITIONS PER ROW
4. 7N MIN. PIN RETENTION IN EITHER DIRECTION.
5. PACKAGING:
= PLASTIC BOX
- = PLASTIC BOX WHEN POLARISATION FEATURE APPLICABLE
U = TUBE AVAILABLE FROM 06 TO 50 POS

6. DIM "C" = (N x 2) + 1.4
EXAMPLE: N = 7
DIM "C" = (7 x 2) + 1.4 = 15.4 mm

8. RoHS COMPATIBLE PRODUCT SPECIFICATIONS

a - PLATING:

- "LF" MEANS THE PRODUCT IS LEAD-FREE,
2µm MINIMUM MATTE TIN OVER 1.27µm
MINIMUM NICKEL UNDERPLATE.

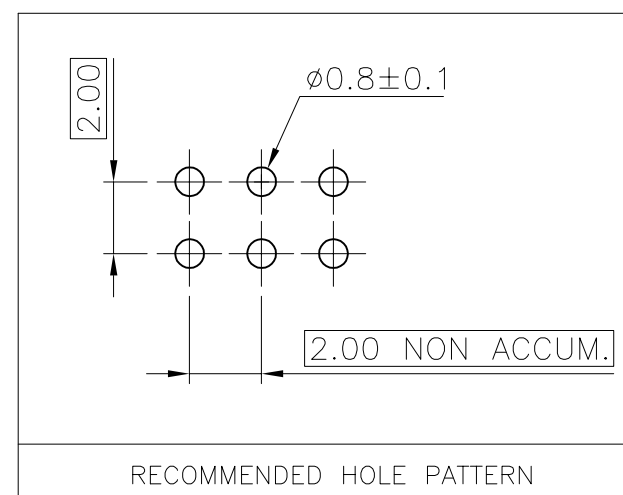
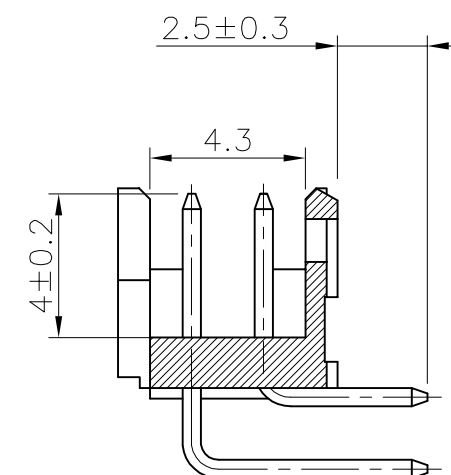
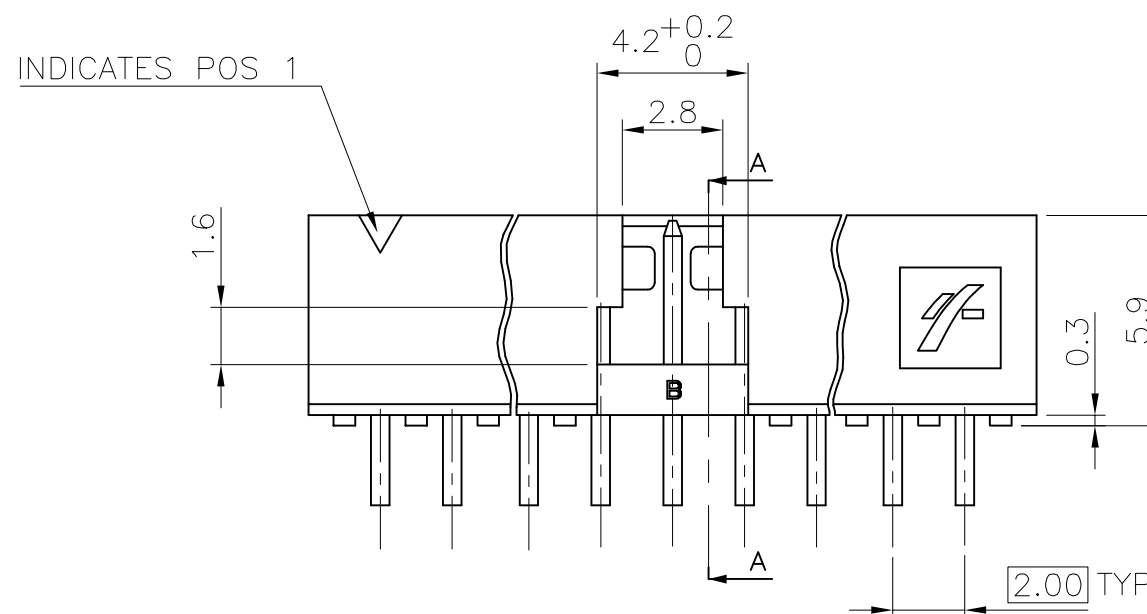
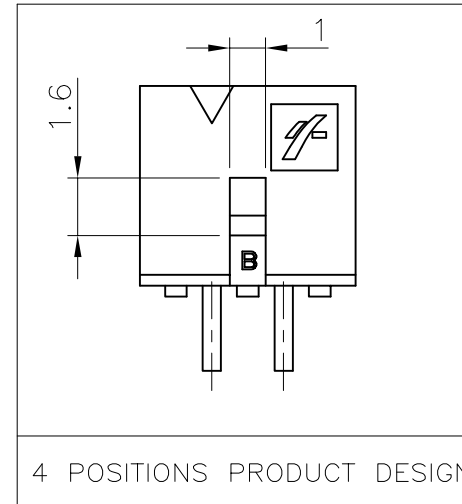
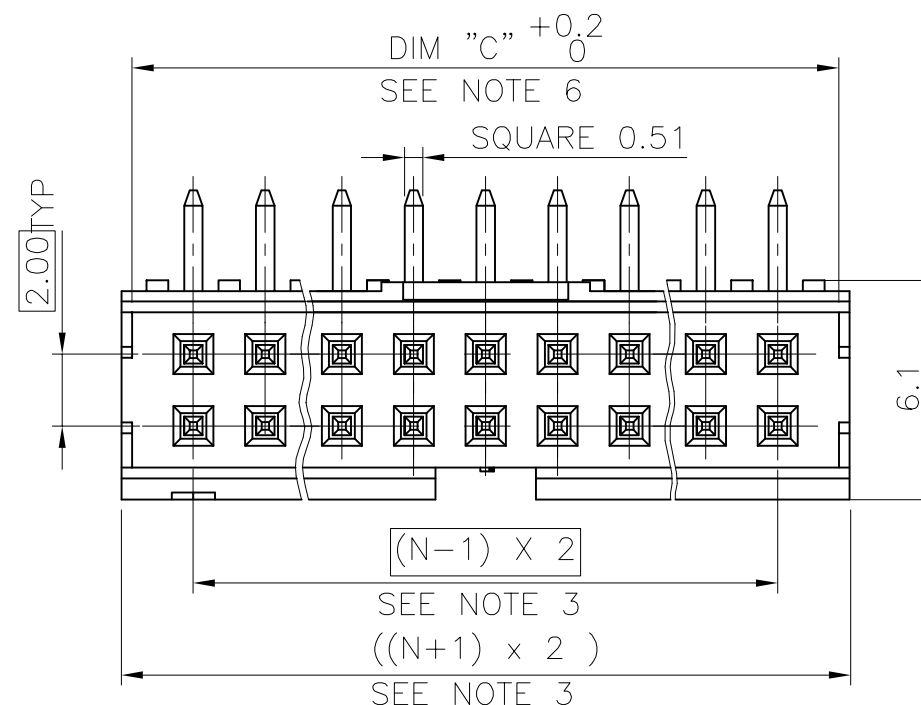
b - MANUFACTURING PROCESS COMPATIBILITY

- THE HOUSING WILL WITHSTAND EXPOSURE TO
260°C ±5°C SOLDER BATH TEMPERATURE FOR
5 SECONDS IN A WAVE SOLDER APPLICATION
WITH A 1.6mm MIN THICK CIRCUIT BOARD.

c - LABELLING:

- MEETS PACKAGING SPECS AS PER GS-14-920

- d - THIS PRODUCT MEETS EUROPEAN DIRECTIVES
AND OTHER COUNTRY REGULATIONS AS DISCRIBED
IN GS-22-008.



mat'l. code				surface	tolerance	projection	product family			
SEE NOTES				ISO 1302	ISO 406	ISO 101	MINITEK			
ltr	ecn no	dr	date	tolerances unless	otherwise specified		title			
D	F20309	LMU	02.05.03	angles	X.X ±0.3	mm	SHR HEADER			
E	F04-0351	JCO	05.01.13	linear	X.XX ±0.13		2.00 RIGHT ANGLE TMT			
F	F06-0210	LMU	06.07.05		X.XXX ±0.05	scale 1:1	dwg no			
G	F08-0113	LMU	08.01.17	dr	L.MULIN	04.09.27	sheet 1 of 1			
				engr	J.COMPAGNON	04.09.27	size			
				chr			98464			
				appd	JM.C	04.09.27	type			
sheet index				revision	sheet		CUSTOMER Drawing			